



17648 U.S. PTO  
111203

# UTILITY APPLICATION

Attorney Docket No.: ASMJP.104DV1

First Named Inventor: Akira Shimizu

Title: METHOD FOR SEMICONDUCTOR WAFER ETCHING

Express Mail Label No.: EV 308022800 US

2386 U.S. PTO  
10/706624



Direct all correspondence to Customer No.: 20995

Date: November 12, 2003

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## Mail Stop Patent Application

United States Patent and Trademark Office

PO Box 1450

Alexandria, VA 22313-1450

The following enclosures are transmitted herewith to be filed in the patent application of:

Inventor(s):

1. Akira Shimizu

2. Kunitoshi Nanba

Assignee of this application: ASM JAPAN K.K.

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## APPLICATION ELEMENTS:

(X) Specification in thirteen (13) pages.

(X) Drawings in one (1) sheet.

(X) A copy of the Declaration by Inventors in two (2) pages.

■ Originally signed

## CONTINUITY INFORMATION:

Application	Relationship	Parent App. No.	Filing Date	Status
This Application	Divisional of	10/068,092	02/05/01	Pending

## FOREIGN CONTINUITY INFORMATION:

Country	Application No.	Filing Date	Priority Claimed
Japan	2001-056685	03/01/01	Yes

(X) Incorporation by Reference. The entire disclosure of the prior application is considered a part of the disclosure of the accompanying application and is hereby incorporated by reference therein.

## OTHER APPLICATION PARTS:

(X) Information Disclosure Statement and PTO-1449 in two (2) total pages (IDS and 1449).

(X) Four (4) references, listing only.

(X) Return prepaid postcard.

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## FILING FEES:

FEE CALCULATION				
FEE TYPE		FEE CODE	CALCULATION	TOTAL
Basic Utility		1001 (\$770)		\$770
Excess Claims > 20	17 20 = 0	1202 (\$18)	0 x 18 =	\$0
Independent > 3	3- 3 = 0	1201 (\$86)	0 x 86 =	\$0
			<b>TOTAL FEE DUE</b>	<b>\$770</b>

(X) A check in the amount of \$770.00 to cover the Total Fee Due is enclosed.

The Commissioner is hereby authorized to charge any additional fees which may be required, now or in the future, or credit any overpayment to Account No. 11-1410.



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MAIL STOP PATENT APPLICATION  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450


**CERTIFICATE OF MAILING BY "EXPRESS MAIL"**

Attorney Docket No. : ASMJP.104DV1  
Applicant(s) : Akira Shimizu, et al.  
For : METHOD FOR SEMICONDUCTOR WAFER  
ETCHING  
Attorney/Agent : Gordon H. Olson/Katsuhiro Arai  
"Express Mail"  
Mailing Label No. : EV 308022800 US  
Date of Deposit : November 12, 2003

I hereby certify that the accompanying

Transmittal letter; specification in 13 pages; 1 sheet of drawing; A copy of  
**SIGNED** Declaration by Inventor in 2 pages; Information Disclosure Statement,  
PTO Form 1449 with 4 references-listing only; \$770.00 Check for Patent  
Application and Assignment Filing Fees; Return Prepaid Postcard

are being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and are addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

  
Nelson Merida

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